



APR 07 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : *Weber* Art Unit : 2814
Serial No. : 09/898,909 Examiner : *P. Cao*
Filed : July 3, 2001
Title : METALLIZATION ARRANGEMENT FOR SEMICONDUCTOR
STRUCTURE AND CORRESPONDING FABRICATION METHOD

Commissioner for Patents
Washington, D.C. 20231

DECLARATION UNDER 37 CFR 1.132

My name is Detlef WEBER. I am an employee of Infineon Technologies, A.G., a German corporation having a principal place of business at St.-Martin-Strasse 53, 81669 Munich, Germany.

I am engineer in the memory Product Division of Infineon Technologies AG, located in Dresden, Germany. I am mainly involved in the development of metallizations of memory chips.

The subject matter that the Examiner refers to as admitted prior art was known as of the time the claimed invention was made only to employees of Infineon Technologies outside the United States, all of whom are under an obligation to keep such knowledge confidential. There has been no description of the foregoing subject matter in any printed publication anywhere in the world.

The foregoing subject matter is not embodied by any product that is on sale or
that has been offered for sale in the United States. Nor has the foregoing subject
matter been used within the United States.

The subject matter that the Examiner refers to as admitted prior art was, at the time the claimed invention was made, owned by, or subject to an obligation of assignment to, Infineon Technologies. The claimed invention was likewise, at the time it was made, owned by or subject to an obligation of assignment to Infineon Technologies.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

D. D. Weber

NAME: Detlef WEBER

March 23 2004

DATE